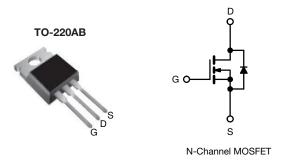
SiHP14N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.269		
Q _g max. (nC)	64			
Q _{gs} (nC)	8			
Q _{gd} (nC)	13			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	TO-220AB				
Lead (Pb)-free and halogen-free	SiHP14N60E-BE3 ^a				
	SiHP14N60E-GE3				

Note

a. "-BE3" denotes alternate manufacturing location

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	v	
Gate-source voltage			V _{GS}	± 30		
Continuous drain current ($T_{,l}$ = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		13		
Continuous drain current $(I_J = 150 \text{ C})$	V _{GS} at 10 V	T _C = 100 °C	I _D	8	А	
Pulsed drain current ^a			I _{DM}	32		
Linear derating factor				1.2	W/°C	
Single pulse avalanche energy ^b			E _{AS}	136	mJ	
Maximum power dissipation			PD	147	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		70		V/ns	
Reverse diode dV/dt ^d		dV/dt	32	v/ns		
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 3.1 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 °C

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-	62					
Maximum junction-to-case (drain)	R _{thJC}	- 0.85			°C/W			
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDITIO	NS	MIN.	TYP.	MAX.	UNI
Static	<u> </u>							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250) μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$		e to 25 °C, I _D	•	-	0.73	-	V/°0
Gate-source threshold Voltage (N)	V _{GS(th)}		V _{GS} , I _D = 250		2.0	-	4.0	V
			$V_{GS} = \pm 20 V$	•	-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
	V _{DS} = 600 V, V _{GS} = 0 V	0 V	-	-	1			
Zero gate voltage drain current	I _{DSS}		, V _{GS} = 0 V, T		-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V		= 7 A	-	0.269	0.309	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 7	' A	-	3.8	-	S
Dynamic	<u> </u>					<u>.</u>		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ $f = 1 MHz$ $V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	1205	-	pF	
Output capacitance	C _{oss}			-	62	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}			-	52	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	177	-		
Total gate charge	Qg				-	32	64	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$ $I_D = 7 A, V_{DS} = 480 V$		-	8	-	nC	
Gate-drain charge	Q _{gd}				-	13	-	1
Turn-on delay time	t _{d(on)}	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 7 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	15	30		
Rise time	t _r			-	19	38	ns	
Turn-off delay time	t _{d(off)}			-	35	70		
Fall time	t _f			-	15	30		
Gate input resistance	R _g	f = 1 MHz, open drain		0.38	0.75	1.5	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	13	^	
Pulsed diode forward current	I _{SM}			-	-	32	A	
Diode forward voltage	V _{SD}	T _J = 25 °	C, I _S = 7 A, V _C	_{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	281	-	ns
Reverse recovery charge	Q _{rr}	$T_J = 2$	5 °C, I _F = I _S = 100 A/us V-	7 A, - 25 V	-	3.4	-	μΟ
Reverse recovery current	I _{RRM}	u/ui =	dl/dt = 100 A/µs, V _R = 25 V		_	22	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

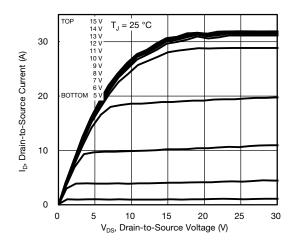


Fig. 1 - Typical Output Characteristics

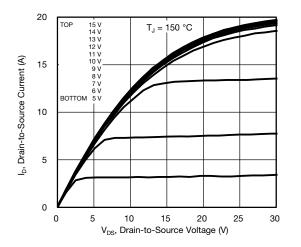
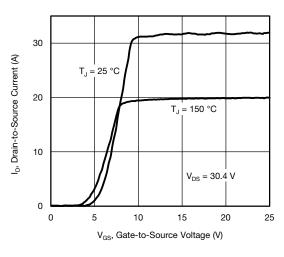


Fig. 2 - Typical Output Characteristics





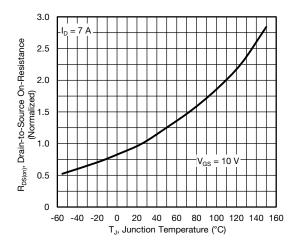


Fig. 4 - Normalized On-Resistance vs. Temperature

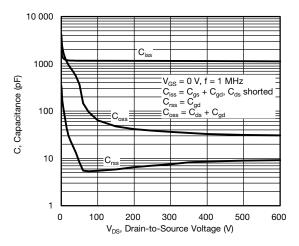


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

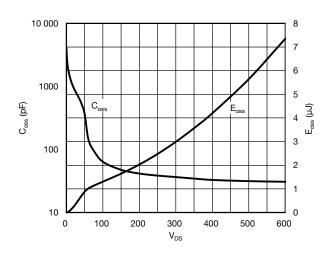


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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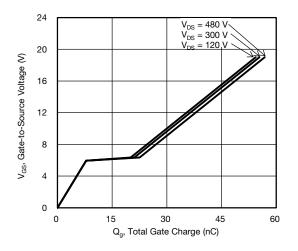


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

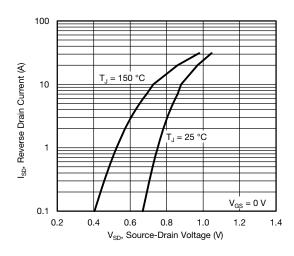


Fig. 8 - Typical Source-Drain Diode Forward Voltage

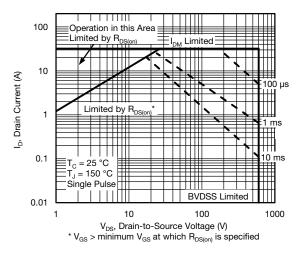


Fig. 9 - Maximum Safe Operating Area

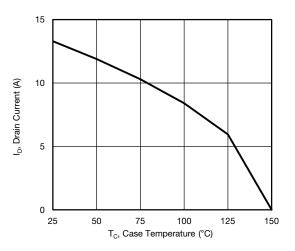


Fig. 10 - Maximum Drain Current vs. Case Temperature

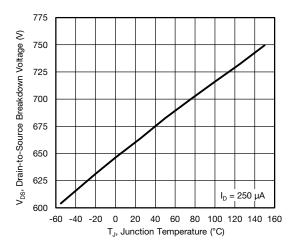
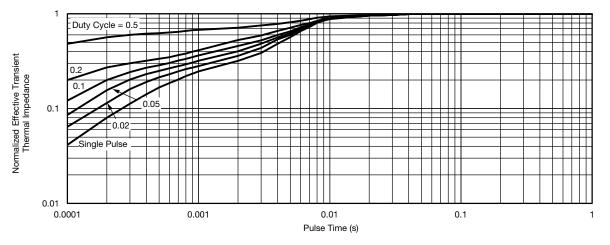


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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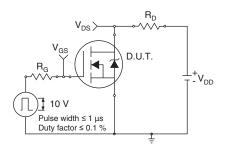


Fig. 13 - Switching Time Test Circuit

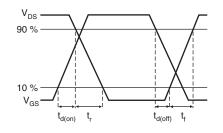


Fig. 14 - Switching Time Waveforms

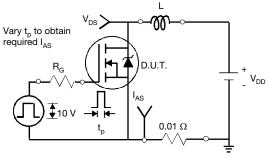


Fig. 15 - Unclamped Inductive Test Circuit

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'ns V_{DD} $\rm V_{\rm DS}$ I_{AS}

Fig. 16 - Unclamped Inductive Waveforms

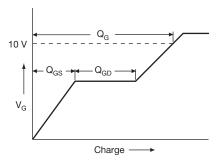
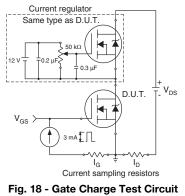


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dV/dt Test Circuit

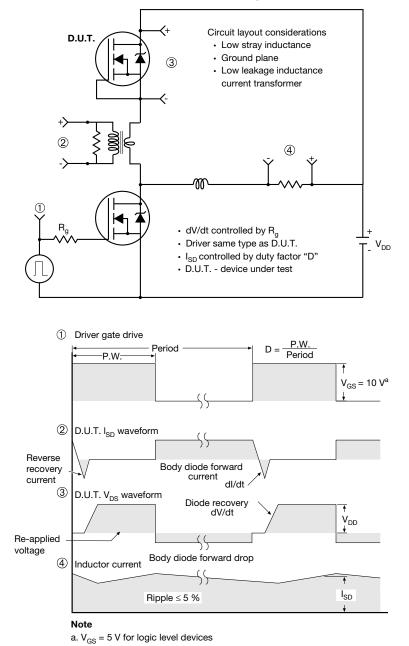
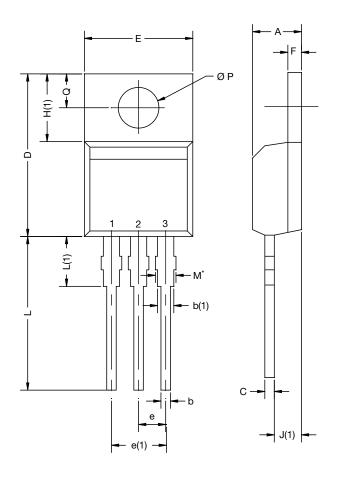


Fig. 19 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INCI	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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